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Part Number:

5019515010

Status:

Active

Description:

0.50mm (.020") Pitch Easy-On™ FFC/FPC Connector, Vertical, SMT, Gold Plating, 50 Circuits

Documents:

3D Model

Drawing (PDF)

Product Specification PS-501951-002 (PDF)

RoHS Certificate of Compliance (PDF)

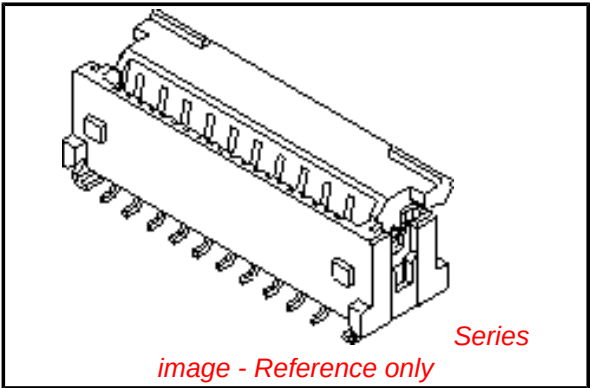
General	
Product Family	FFC/FPC Connectors
Series	501951
MolexKits	Yes
Product Name	Easy-On™
Physical	
Circuits (Loaded)	50
Circuits (maximum)	50
Color - Resin	Brown, Natural
Contact Position	N/A
Durability (mating cycles max)	20
Entry Angle	Vertical
Mated Height (in)	0.159 In
Mated Height (mm)	4.05 mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Gold
Number of Rows	1
Orientation	Vertical
PCB Locator	No
PCB Retention	Yes
Packaging Type	Embossed Tape on Reel
Pitch - Mating Interface (in)	0.020 In
Pitch - Mating Interface (mm)	0.50 mm
Pitch - Term. Interface (in)	0.020 In
Pitch - Term. Interface (mm)	0.50 mm
Polarized to PCB	No
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-25°C to +85°C
Termination Interface: Style	Surface Mount
Wire/Cable Type	FFC/FPC

Electrical	
Current - Maximum per Contact	0.4A
Voltage - Maximum	50V AC (RMS)/DC

Material Info

Reference - Drawing Numbers

Packaging Specification	SPK-501951-001
Product Specification	PS-501951-002, RPS-501951-001, RPS-501951-002, RPS-501951-003, RPS-501951-004, RPS-501951-005, RPS-501951-006, RPS-501951-007, RPS-501951-009, RPS-501951-015
Sales Drawing	SD-501951-003, SD-501951-004



EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Not Reviewed

Halogen-Free

Status

Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

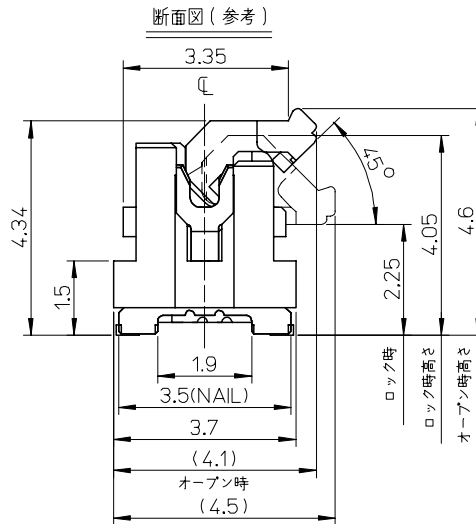
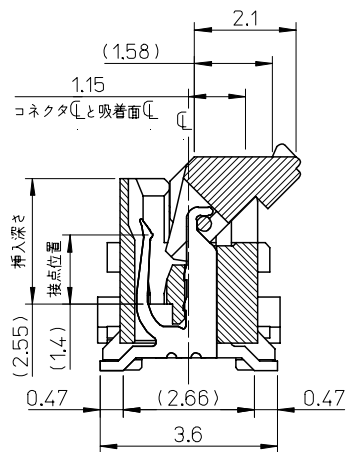
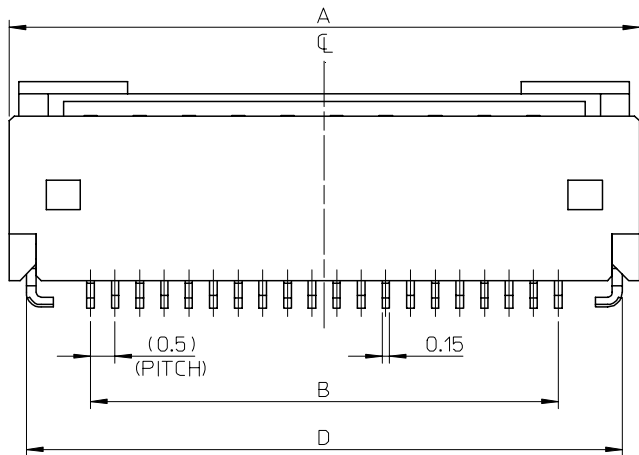
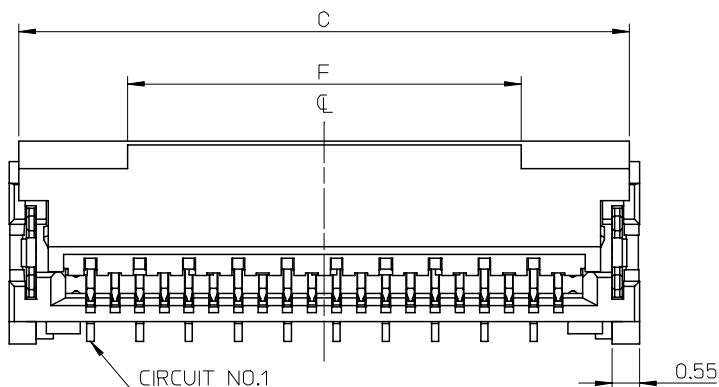
Search Parts in this Series

501951Series

This document was generated on 06/07/2010

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10 9 8 7 6 5 4 3 2 1



注記 NOTES

- 使用材料 MATERIAL
ハウジング : 液晶ポリマー ガラス充填, UL94V-0(白)
HOUSING : LIQUID CRYSTAL POLYMER
GLASS FILLED, UL94V-0 (WHITE)
アクチュエータ : ポリアミド 9T, ガラス充填, UL94V-0(茶)
ACTUATOR : POLYAMIDE 9T, GLASS FILLED,
UL94V-0 (BROWN)
ターミナル : 銅合金(t=0.15)
TERMINAL : COPPER ALLOY
金具 : 銅合金(t=0.2)
FITTING NAIL : COPPER ALLOY
 - めっき仕様 PLATING
ターミナル TERMINAL
ニッケル下地めっき
GOLD(AU) OVER NICKEL(NI) PLATING.
金具 FITTING NAIL
ニッケル下地めっき
TIN(Sn) OVER NICKEL(NI) PLATING.
 - テールと金具を併せた平坦度は 0.1ミリメートル以下(リフロー前)
TAILS AND NAILS COPLANARITY
TO BE 0.1 MAX. (BEFORE REFLOW)
 - ELV及びRoHS適合品
ELV AND RoHS COMPLIANT
- ⚠ R0.3は、FPC導体部にかからないこと。
R0.3 MUST NOT BE OVERLAPPED
TO PATTERN OF FPC.

8	35.7	37.1	37.4	34.5	37.8	501951-7019	70
	30.7	32.1	32.4	29.5	32.8	501951-6019	60
	25.7	27.1	27.4	24.5	27.8	501951-5019	50
	23.2	24.6	24.9	22	25.3	501951-4519	45
	20.7	22.1	22.4	19.5	22.8	501951-4019	40
	16.7	18.1	18.4	15.5	18.8	501951-3219	32
	15.7	17.1	17.4	14.5	17.8	501951-3019	30
	12.7	14.1	14.4	11.5	14.8	501951-2419	24
	11.7	13.1	13.4	10.5	13.8	501951-2219	22
	10.7	12.1	12.4	9.5	12.8	501951-2019	20
F	E	D	C	B	A	MATERIAL NO. CIRCUITS	

REVISED EC NO: J2008-1229 DRAWN:YAJIMA CHKD:THARUYAMA APPR:NUKITA	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY TRSUZUKI	DATE 2006/08/21	TITLE 0.5 FPC CONN. HSG ASSY EASY ON / STRAIGHT (GOLD)				
		10 OVER 30 UNDER	±0.25	CHECKED BY HHIRATA	DATE 2006/08/21					
		30 OVER	±0.3	APPROVED BY MSASAO	DATE 2006/08/21	MOLEX INCORPORATED				
		ANGULAR ±1 °		MATERIAL NO.						
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-501951-003		1 OF 2		
		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

10 9 8 7 6 5 4 3 2 1

F

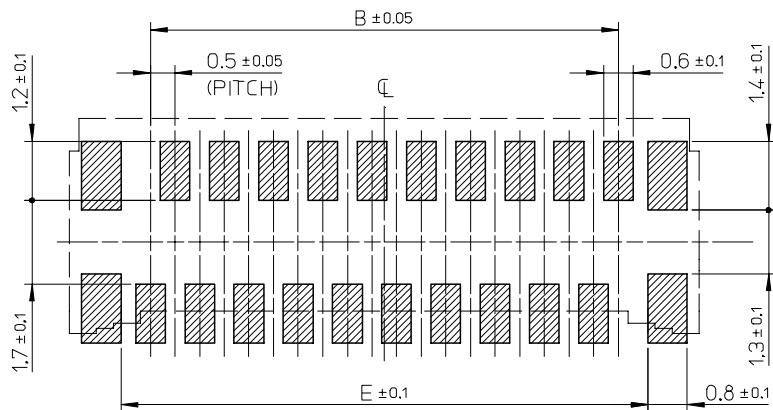
E

D

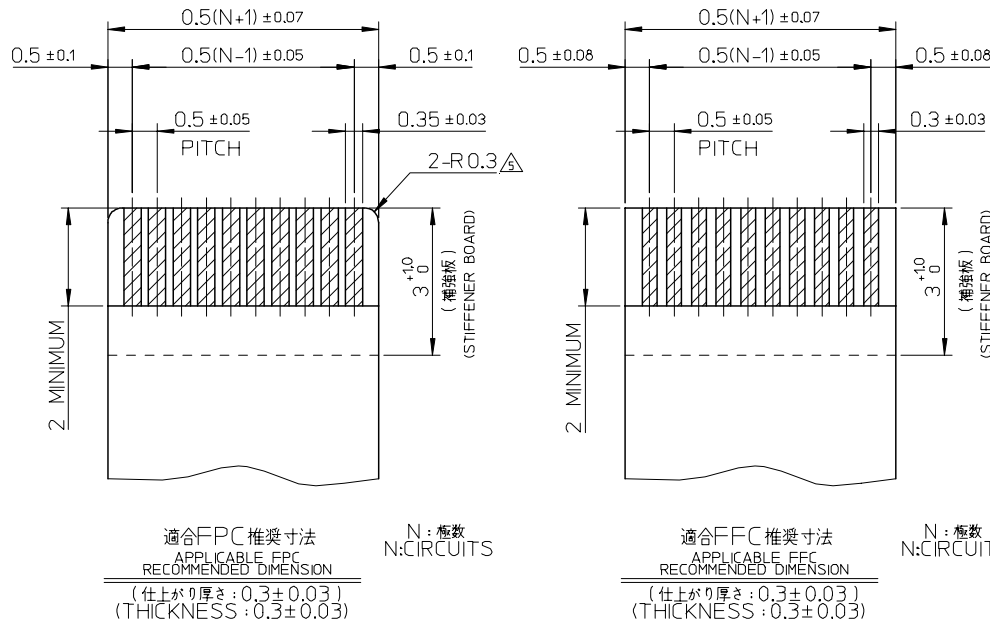
C

B

A



参考基板レイアウト (マウント面)
P.C. BOARD PATTERN DIMENSION (REF.)
(MOUNT AREA)



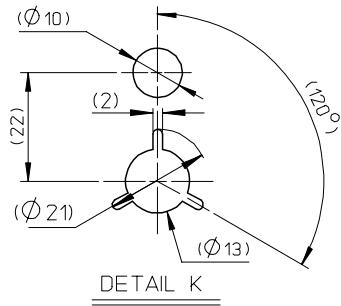
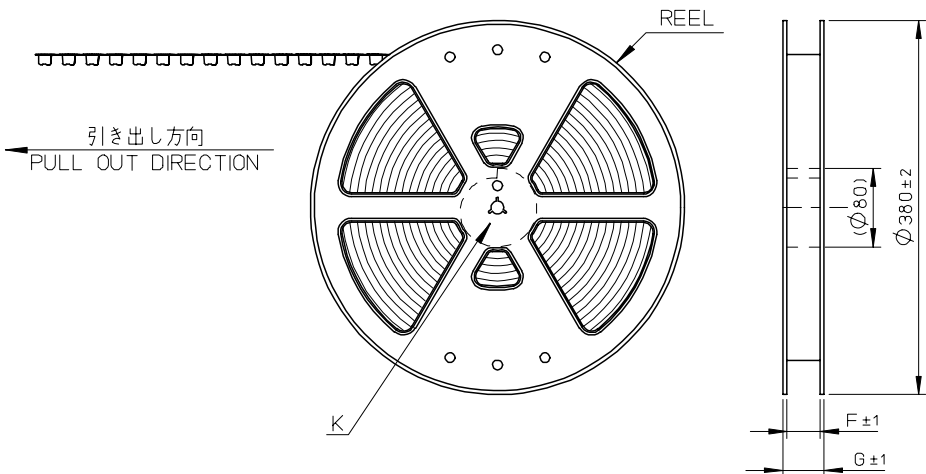
FPC について:

打ち抜き方向は導体側から補強板側を推奨します。
導体部については軟銅箔35 μ mまたは50 μ mを推奨します。
補強フィルム材質はポリイミドを推奨します。ベースフィルムは25 μ mを推奨します。
接着剤は熱硬化接着剤を推奨します。
尚、接着剤の接点部への付着は導通不良の原因になりますので、染み出しが無い様お願い致します。

ABOUT FPC

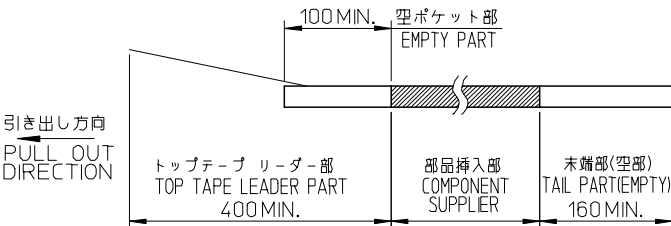
RECOMMENDED PUNCHER DIRECTION : FROM CONDUCTOR SIDE TO STIFFENER FILM SIDE.
RECOMMENDED CONDUCTOR SPEC :
THICKNESS OF SOFT COPPER FOIL : 35 MICROMETER OR 50 MICROMETER.
RECOMMENDED MATERIAL/THICKNESS.
STIFFENER FILM : POLYIMIDE
BASE FILM THICKNESS : 25 μ m
BONDING AGENT : THERMOSETTING BONDING AGENT
PLEASE PUT APPROPRIATE AMOUNT OF ADHESIVE ON ADHEREND BECAUSE THERE IS A POSSIBILITY THAT THE EXTRA ADHESIVE CAUSES THE DEFECT IN ELECTRICAL CONTINUITY.

SEE SHEET 1 EC NO: J2008-1229 DRAWN:HAJI MA 2007/10/11 CHKD:THARUYAMA 2007/10/11 APPR:NUKITA 2007/10/12	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	
		10 UNDER	± 0.2	DRAWN BY TRSUZUKI	DATE 2006/08/21	TITLE 0.5 FPC CONN. HSG ASSY EASY ON / STRAIGHT (GOLD)			
		10 OVER 30 UNDER	± 0.25	CHECKED BY HIRATA	DATE 2006/08/21				
		30 OVER	± 0.3	APPROVED BY MSASAO	DATE 2006/08/21	 MOLEX INCORPORATED			
		ANGULAR ±1 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-501951-003				2 OF 2
D	REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



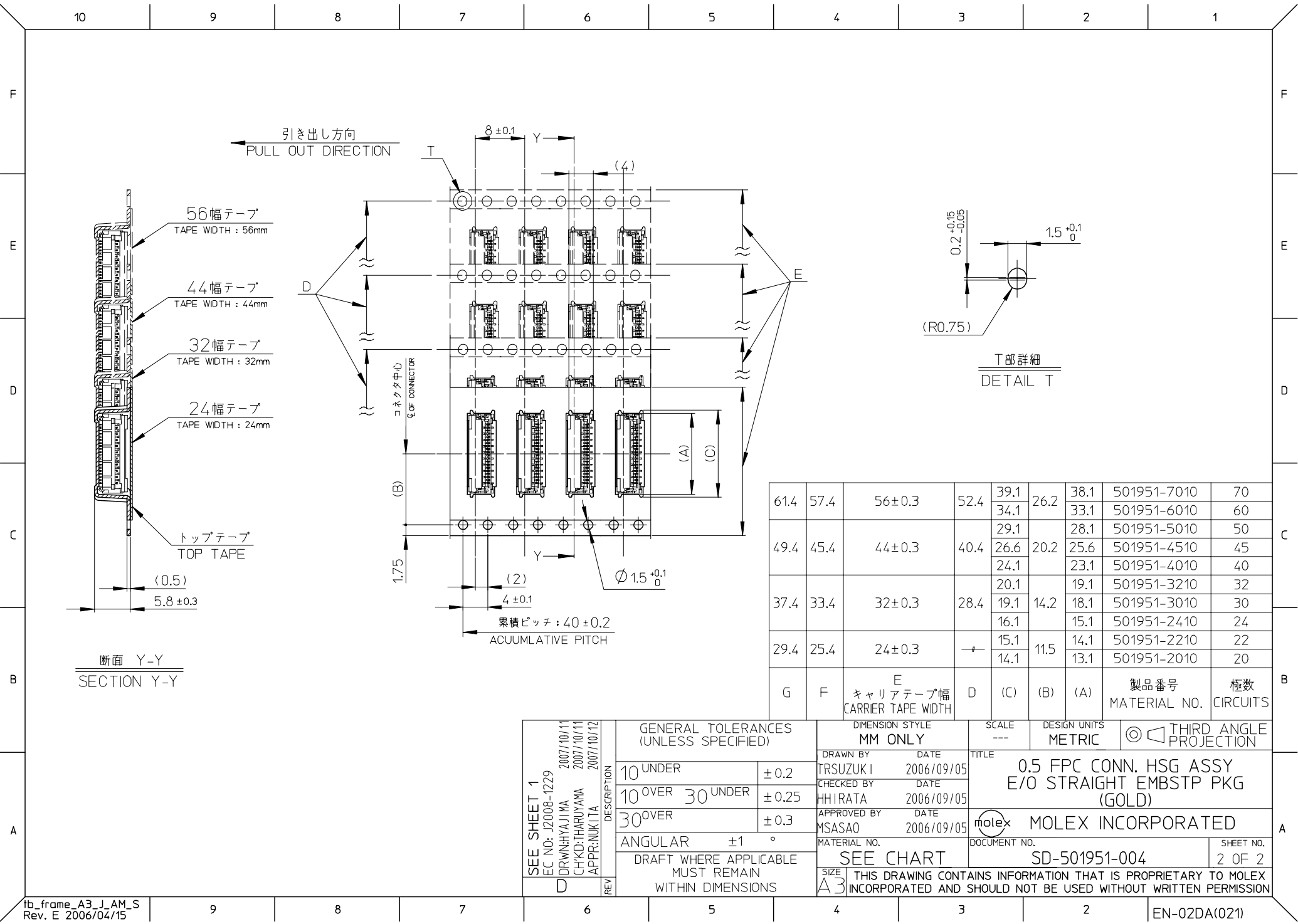
NOTES

- 1. 製品詳細寸法については図面 SD-501951-003を参照下さい。
FOR DIMENSIONS OF PRODUCT, REFER TO RSD-501951-007.
- 2. 梱包数量 : 2000個/リール
NUMBER OF CONNECTORS : 2000PIECES/REEL
- 3. リードテープ長さ
LEAD TAPE LENGTH



- 4. 材料 MATERIAL
キャリアテープ : ポリプロピレン
CARRIER TAPE : POLYPROPYLENE
トップテープ : ポリエチレンテレフタレート, ポリエチレン
TOP TAPE : POLYETHYLENE TEREPHTHALATE , POLYETHYLENE
リール : ポリスチレン<リサイクル材を含む>
REEL : POLYSTYRENE<RECYCLE MATERIAL CONTAINED>
- 5. ELV及びRoHS適合品 ELV AND RoHS COMPLIANT

REVISED EC NO: J2008-1229 D DRAWN:HYAJIMA CHKD:THARUYAMA APPR:NUKITA	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY TRSUZUKI	DATE 2006/09/05	TITLE 0.5 FPC CONN. HSG ASSY E/O STRAIGHT EMBSTP PKG (GOLD)				
		10 OVER 30 UNDER	±0.25	CHECKED BY HHIRATA	DATE 2006/09/05					
		30 OVER	±0.3	APPROVED BY MSASAO	DATE 2006/09/05	MOLEX INCORPORATED				
		ANGULAR ±1°		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 2		SD-501951-004		1 OF 2		
			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



61.4	57.4	56±0.3	52.4	39.1	26.2	38.1	501951-7010	70
				34.1		33.1	501951-6010	60
49.4	45.4	44±0.3	40.4	29.1	20.2	28.1	501951-5010	50
				24.1		23.1	501951-4510	45
				20.1		19.1	501951-3210	32
37.4	33.4	32±0.3	28.4	19.1	14.2	18.1	501951-3010	30
				16.1		15.1	501951-2410	24
29.4	25.4	24±0.3	—	15.1	11.5	14.1	501951-2210	22
				14.1		13.1	501951-2010	20
G	F	E キャリアテープ幅 CARRIER TAPE WIDTH	D	(C)	(B)	(A)	製品番号 MATERIAL NO.	極数 CIRCUITS

SEE SHEET 1 EC NO: J2008-1229 DRAWN BY JIMA CHKD: THARUYAMA APPR: NUKITA REV: D	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
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		ANGULAR ±1 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-501951-004		2 OF 2		
				THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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